

Multicore 502 Cored Solder Wire

Product Images



Description



- No-clean
- Clear residue
- Standard and lead-free options
- Minimal activation for increased wetting speed
- Halide Content: 0.2%
- IPC Class: ROM1
- Alloy Options (Sn/Pb): 60/40, 63/37, SN62
- Flux Content by Weight: 3%